

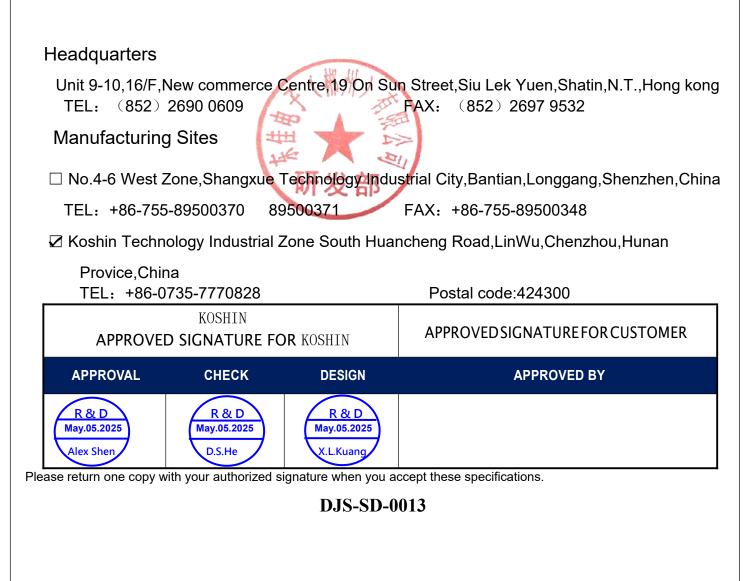
This product is completed the Lead-free & RoHS2.0 & Halogen-free.

Issued Date	2025-5-6
No.	RD20250506001

SPECIFICATION FOR APPROVAL

Nc	Customer No.	Koshin Part No.	Description	ΦD x L
1		MRW-035V221MF100-T/R	35V220µF	8X10

KOSHIN INTERNATONAL LIMITED



V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS

Make/revised curriculum vitae

Version	Date	Res.	Content	Checked
A0	2025-5-6	邝秀兰	新建	何东石



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V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS

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V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS

1. Scope

This specification covers"MRW series" V-Chip Aluminium Electrolytic Capacitors.

2.Operating Temperature Range

Operating temperature range is the range of ambient temperature at which the capacitor can be operated continuously at rated voltage.

3.Characteristics

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows.

Ambient temperature : 15 to 35° C

Air pressure: 86kpa to 106kpa

If there may be doubt on the results, measurements shall be made within the following limits.

Ambient temperature : 20±2°C

Air pressure: 86kpa to 106kpa

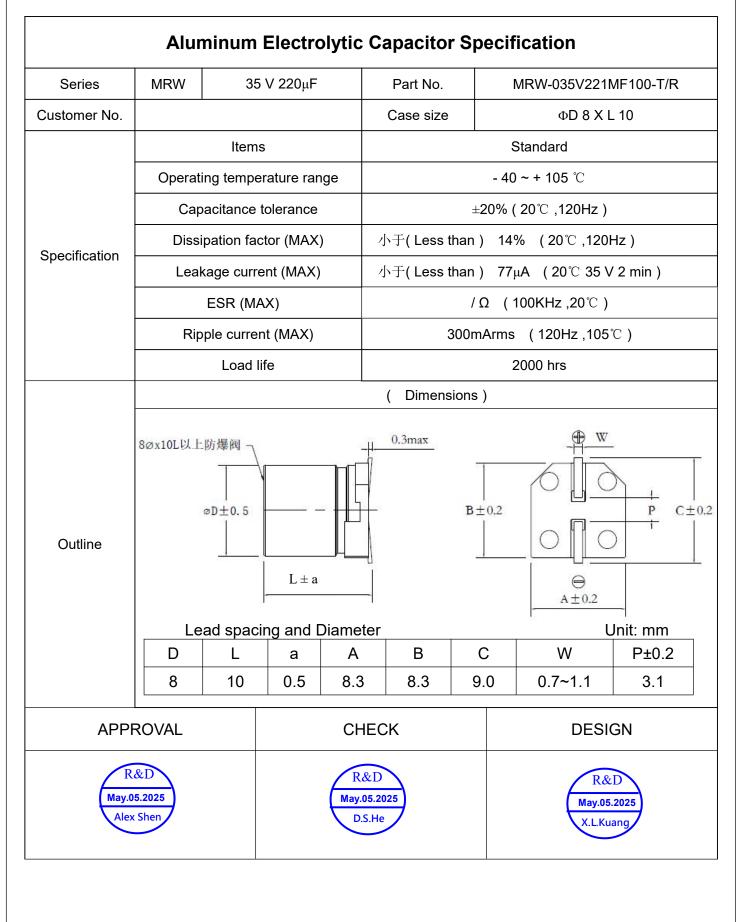
4. Frequency Coefficient for Ripple Current

Case Code	Frequency (Hz) Capacitance(µF)	120	1K	10K	100K
	1.0	1.00	1.50	1.75	1.80
B057-G105	2.2 to 10	1.00	1.30	1.40	1.50
	22 to 1,500	1.00	1.05	1.08	1.08

5.Max. Impedance Ratio

Low	Rated vo	ltage(V)	6.3	10	16	25	35	50	63	100	
Low temperature characteristics	Impedance	Z _{(-25°C})/ Z _{(+20°C})	4	3	2	2	2	2	2	3	120Hz
characteristics	ratio (max)	Z _(-40°C) / Z _(+20°C)	12	8	6	4	3	3	3	4	

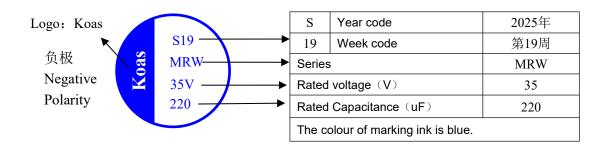
6.Characteristics Table





7.Marking

7.1. Marking on capacitors includes:

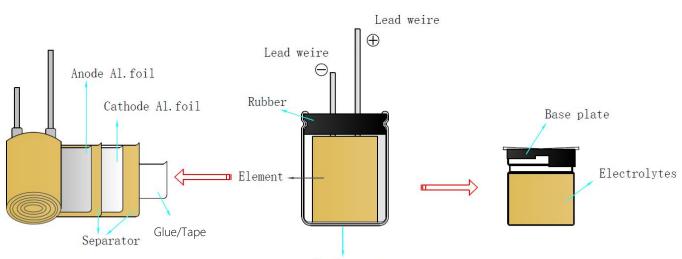


Year Code

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	N	Р	R	S	Т	V	W	Х	Y



8. Inner conformation drawing and inner constitute parts(curtness drawing)



Aluminum case

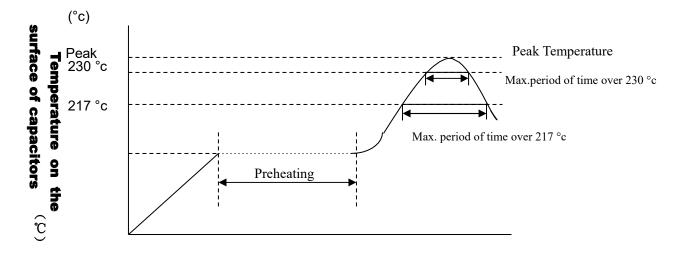
Composing Part	Material
Lead Wire	Fe+Al+Cu+Sn
Case	Aluminum
Base Plate	PPA
Paper	Cellulose
Anode Foil	Aluminum Foil
Cathode Foil	Aluminum Foil
Electrolyte	GBL
Seal	Rubber
Glue/Tape	Poly/OPP



9. Recommended soldering heat conditions:

RECOMMEDEDSOLDERINGCONDITIONSFORALUMINIUM SURFACE MOUNT TYPE

-Air or Infrared reflow soldering



Time(Sec)

SMDshape	size	voltage	preheating	Time	Time	Peak	Reflow
				maintained	maintained	temperature	numbe
				over 217 °c	over 230 °c		r
	B52~E87	4~63∨		≤90 Sec	≤60 Sec	≤260 °c	≤2 times
		63V,80V		≤60 Sec	≤40 Sec	≤250 °c	≤2 times
	F63~G100	4~50V		≤60 Sec	≤30 Sec	≤245 °c	≤2 times
		63V~100,	150 - 180C	≤30 Sec	≤20 Sec	≤240 °c	≤2 times
		400∨	≤120Sec.				
	H135~K21	6.3~50V		≤30 Sec	≤20 Sec	≤240 °c	≤2 times
	5	63~450V	-	≤20 Sec	_	≤230 °c	≤2 times

Remark: Reflow number cannot over 2 times. After first time reflow , must be ensure that the temperature of capacitors became cold to room temperature($5\sim35^\circ$ C) ,then continue second flow.



10. Electrical characteristics:

NO.	ITEM		TEST METHO	DD	SPECIFICATION
10.1	Rated voltage	Voltage	: DC voltage + peak ripple voltage	See 6.Characteristics Table	
10.2	Capacitance	2.Meas	uring frequency: $120Hz \pm 12Hz$ uring voltage: $\leq 0.5Vrms+0.5VDC$ uring circuit: ()	See 6.Characteristics Table	
10.3	Dissipation factor				See 6.Characteristics Table
10.4	Leakage current				 4X5.7-10X10.5,6.3V-100V Less than 0.01CV or 3μA, whichever is large (at 20°C, 2 minutes) 12.5X13.5-18X21.5,10-100V Less than 0.03CV or 4μA, whichever is large (at 20°C, 1minutes) I: Leakage current(μA) C: Capacitance(μF) V: Rated voltage (V)
10.5	Turneture	V: DC	current meter S2: voltage meter C _x :	Switch Switch for protect of current meter Testing capacitor	St
10.5	Temperature characteristi cs 温度特性	STEP 步骤 1 2	TEMPERATURE 温度 20℃±2℃ -40℃±3℃ -55℃±3℃	STORAGE TIME 放置时间 30minutes 2hours	Step2. Low temperatur impedance stability Less than specified value.
		3	20°C±2°C	4hours	Step4.
		4	105°C±2°C	Capacitance change:	
		-	Acasure the capacitance and imper Z , 20°C,120Hz \pm 2HZ)	within \pm 10% of the initial measured value.	
			Measure the impedance at thermal		Dissipation factor: Less than specified value.

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Γ	NO.	ITEM		r.	FES	ΓM	ETH	OD					SPECIFICATION
	10.6	Surge test	Rated surge voltage shall be applied (switch on)for 30 ± 5 second and then shall be applied (switch off) with discharge for 5.5min at room temperature. This cycle shall be repeated for 1000 cycles. Duration of one cycle is 6 ± 0.5 minutes									Capacitance change: within±15% of the initial specified value.	
			limues										Dissipation factor: Less than specified value.
			Surge voltage										Leakage current: Within initial specified value.
			Working voltage(V) 工作电压(V)	6.3	10	16	25	35	50	63	80	100	
			Surge voltage (V) 浪涌电压(V)	8	13	20	32	44	63	79	100	125	

11.Mechanical characteristics:

NO.	ITEM	TEST METHOD	SPECIFICATION
11.1	Lead strength	(A)Tensile strength: wire lead terminal: $d(mm) \leq 0.5 0.5 < d \le 0.8 0.8 < d \le 1.25$ load(kg) 0.5 1.0 2.0 The capacitor shall withstand the constant tensile force specified between the body and each lead for 10 seconds without damage either mechanical or electrical	
		(B) Bending strength: wire lead terminal: $\boxed{d(mm) \leq 0.5 0.5 < d \le 0.8 0.8 < d \le 1.25} \\ \boxed{load(kg) 0.5 0.5 1.0} \\ \hline$ with the capacitor in a vertical position apply the load specified axially to each lead. The capacitor shall be rotated slowly from the vertical to the horizontal position, back to the vertical position. The 90 ° in the opposite direction and back the original position. Performance of capacitor shall not have change and leads shall be undamaged.	When the capacitance is measured, there shall be no intermittent contacts, or open-or short-circuiting. There shall be no such mechanical damage as terminal damage etc.

K	oas	V-CHIP ALUMINUM ELECTROLYTIC CAI	PACITORS
NO. 11.2	ITEM Vibration resistance	TEST METHOD The frequency of the vibration shall vary uniformly within the range 10 to 55 Hz with the amplitude of 0.75mm, completing the cycle in the internal of one minute. The capacitor shall be securely mounted by its leads with hold the body of capacitor. The capacitor shall be vibrated in three mutually perpendicular directions for a period of 2 hours in each direction.	SPECIFICATION Capacitance: no unsteady. Appearance: no abnormal. Capacitance change: within ± 5% of initial measured value.
11.3	Solder -ability	The leads are dipped in the solder bath of Sn at $235^{\circ}C\pm 5^{\circ}C$ for 2 ± 0.5 seconds. The dipping depth should be set at $1.5\sim 2.0$ mm.	The solder alloy shall cover the 95% or more of dipped lead's area.

12. Reliability:

NO.	ITEM	TEST METHOD	SPECIFICATION
12.1	Soldering heat resistance	The leads immerse in the solder bath of Sn at 260°C±5°C for 10±1seconds until a distance of 1.5~2.0mm from the case.	No visible damage or leakage of electrolyte. Capacitance change: Within \pm 5% of the initial measured value Tan δ : Less than specified value. Leakage current: Less than specified value
12.2	Moisture Resistance	Subject the capacitor to 40 °C \pm 2 °C and 90% to 95% relative humidity for 504 hours.	Capacitance change: Within \pm 20% of the initial measured value Tan δ : Less than 1.2 specified value. Leakage current: Less than specified value

Koas v-chip aluminum electrolytic capacitors

		V-CHIP ALUMINUM ELECTROLY TIC CAPA				
NO.	ITEM	TEST METHOD	SPECIFICATION			
12.3	Load life	After 2000 hours continuous application of DC rated working voltage and rated ripple current at $105 \degree C \pm 2 \degree C$, Measurements shall be performed after 16 hours exposed at room temperature.	Capacitance change: within±20% of the initial specified value. Dissipation factor: Less than 200% of the initial			
12.4	Shelf life	After storage for 1000 hours at 105 °C \pm 2 °C without voltage application ,Measurements shall be performed after exposed for 16 hrs at room temperature after application of Testing	specified value. Leakage current: Within initial specified value.			
12.5	Storage at low temperature	The capacitor shall be stored at temperature of $-40^{\circ}C \pm 3^{\circ}C$ for 16 hours, during which time be subjected to standard atmospheric conditions for 16 hours or more. After which measurements shall be made.	Capacitance change: Within $\pm 10\%$ of the initial value. Tan δ :less than specified value Leakage current: Less than specified value. Appearance :no Abnormal.			
12.6	Pressure relief	DC test Send the following electricity while applying the inverse voltage. Where case size D≤22.4mm:1 A d.c.max D > 22.4mm:10 A d.c.max Note: 1.This requirement applies to capacitors with a diameter of 6 mm or more. 2. When the pressure relief device does not open even 30 minutes after commencement of test, the test may be ended.	DC test circuit S C power 通過通過 C x C x C x C x C x C x C x C x			

V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS

13.Koshin Part No

Part Number System

MRW-035V 221 M F 100 - T/R

1 2 3 4 5 6 7

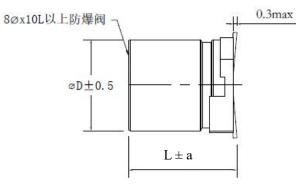
(1) Series	
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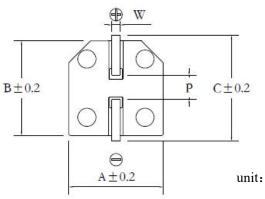
MRS	MRW	/	MRH		MRL	MF	RB	MRI	N	MRE		MRA		MRF		MRT	
(2) Voltage	e(WV))				1	I										
Voltage(W)	V 4	6	6.3	10	16		25	35	50	6	3	80	100	1	10	115	
Code	004	4 6	R3	010	016	6 0	25	035	050	0	63	080	100	1	10	115	
Voltage(W V)	125	1	60	165	200) 2	20	250	330) 3	50	400	450	5	00	550	
Code	125	1	60	165	200) 2	20	250	330) 3!	50	400	450) 50	00	550	
(3) Capac Capacitanc			n mic	rofara	ads (µF))			I				I				
μF	0.1		0.4	47	1		2	.2	2	2	2	20	2	200	22	2000	
Code	0R1		R	47	01	010 2		۲2	220		2	221		222		223	
(4) Capac	itance	e tole	rance)	_1						1						
Tolerance %	±	:5	-	±10	±	15	1	±20	-0 tc	+100	-0 t	to +20	-10	to +20		10 to +100	
Code		J		K		L		М		Ρ		R		V		W	
Tolerance %		5 to 20		20 to +40		0 to 80	-20	to +5	+5 t	o +20	-10) to +5		80 to ⊦20	-15	5 to +5	
Code	1	N		Х		E		A		В		С		D		F	
(5) Case	D: n	1m)						İ			· 						
Diame	eter		4		5		6.3	8	3	10		12.5		16		18	
Cod	le		В		С		Е	F	-	G		Н		J		K	
(6) Case	(L: m	m)	1	I	I		1		I	1				1	1	1	
Description	5	7	11	12.	5 25	35.5	40	100	110	111	120	130	140	150	220	250	
Code	050	070	110	12	5 250	355	400	A00	A10	A11	A20	A30	A40	A50	B20	B50	
(7) Lead tr	eatme	ent						1		1		1	l	1	1	<u> </u>	
Descript																	

V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS

14.Product processing diagram:

14.1.Product size drawing:

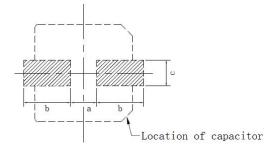




unit: mm

ΦD	L	а	A	В	С	W	P±0.2
5	5.7	0.5	5.3	5.3	5.9	0.5~0.8	1.4
6.3	5.4/5.7	0.5	6.6	6.6	7.2	0.5~0.8	1.9
6.3	7.7	0.5	6.6	6.6	7.2	0.5~0.8	1.9
8	7	0.5	8.3	8.3	9.0	0.7~1.1	3.1
8	10.5	0.5	8.3	8.3	9.0	0.7~1.1	3.1
10	10.5	0.5	10.3	10.3	11.0	0.7~1.1	4.7
12.5	13.5	1.0	13.0	13.0	13.7	1.0~1.3	4.2
12.5	16.5	1.0	13.0	13.0	13.7	1.0~1.3	4.2
16	16.5	1.0	17.0	17.0	18.0	1.0~1.3	6.5
16	21.5	1.0	17.0	17.0	18.0	1.0~1.3	6.5
18	16.5	1.0	19.0	19.0	20.0	1.0-1.3	6.5
18	21.5	1.0	19.0	19.0	20.0	1.0-1.3	6.5

14.2 Land/Pad Pattern



Solder land on PC board

		unit: mr	n
Size	а	b	c
C052,C057	1.4	3.0	1.6
E052,E057,E077	1.9	3.5	1.6
F063	2.3	4.5	1.6
F100	3.1	4.2	2.2
G100	4.5	4.4	2.2
H135,H160	4.0	5.7	2.5
J165,J215	6.0	6.9	2.5
K165,K215	6.0	7.9	2.5

V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS

15.Packing

15.1 Taping Specification for SMD Type

15.1.1 Carrier Tape

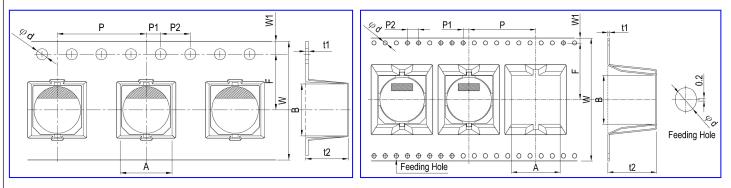




Fig. 1-2

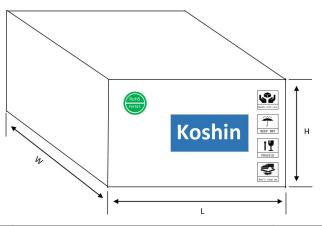
											Unit: m	m
4 DVI	А	В	φd	F	Р	P1	P2	t1	t2	W	W1	Fig.No.
φ DXL	± 0.2	± 0.2	± 0.1	max	± 0.2	± 0.3	± 0.15	F1g.1NO.				
5X5.7	5.7	5.7	1.5	5.5	12	2.0	4.0	0.6	6.3	12	1.75	1-1
6.3X5.4/5.7	7.0	7.0	1.5	7.5	12	2.0	4.0	0.6	6.3	16	1.75	1-1
6.3X7.7	7.0	7.0	1.5	7.5	12	2.0	4.0	0.6	8.3	16	1.75	1-1
8X7	8.7	8.7	1.5	11.5	16	2.0	4.0	0.6	8.8	24	1.75	1-1
8X10.5	8.7	8.7	1.5	11.5	16	2.0	4.0	0.6	11.0	24	1.75	1-1
10X10.5	10.7	10.7	1.5	11.5	16	2.0	4.0	0.6	11.0	24	1.75	1-1
12.5X13.5	13.4	13.4	1.5	14.2	24	2.0	4.0	0.6	15	32	1.75	1-2
12.5X16.5	13.4	13.4	1.5	14.2	24	2.0	4.0	0.6	17.5	32	1.75	1-2
16X16.5	17.5	17.5	1.5	20.2	28	2.0	4.0	0.5	17.5	44	1.75	1-2
16X21.5	17.5	17.5	1.5	20.2	28	2.0	4.0	0.5	22.5	44	1.75	1-2
18X16.5	19.5	19.5	1.5	20.2	32	2.0	4.0	0.5	17.5	44	1.75	1-2
18X21.5	19.5	19.5	1.5	20.2	32	2.0	4.0	0.5	22.5	44	1.75	1-2

15.1.2 Reel Package

	000000000 0000000000000000000000000000	×	Reel	Polarity	Pull o	ut direction	_
	Space to show	remains		+) O O - +	0 0 - +	_
Case size	Φ5	Ф6.3	Φ8x7	Φ8x8~12.5	Φ10	Ф12.5	Φ16~18
W	14	18	18	26	26	34	46
А	380	380	380	380	380	380	380
t	3.0	3.0	3.0	3.0	3.0	3.0	3.0



15.1.3 Packing specification



Product size	Cart	ton size ± 2	(mm)		
Floduct size	L	W	Н	Q'ty / Reel	Q'ty / Box
5X5.2~7	410	410	285	1000	12000
6.3X5.2~7.7	410	410	285	1000	10000
6.3X11	410	410	285	500	5000
8X6.5~11	410	410	285	500	4000
8X12	410	410	285	400	3200
10X8~10.5	410	410	285	500	4000
10X13.5	410	410	285	400	3200
12.5X13.5	410	410	285	200	1200
18X16.5	410	410	285	125	500

15.1.4 Label:

Series	Size(mm)	Sample	OPN:	3	ectrolytic Capacitors $\times \times \times \times @$ \otimes	
Label	90×40	As the right	Type: CPN: ①	567 4	Qty: 9 pcs Work order number:	KS2020011302450

①Customer name

②D/C

3Koshin Part No.

④ Customer Part No.

⁽⁵⁾Series

⁽⁶⁾Voltage

 \bigcirc Capacity

Size

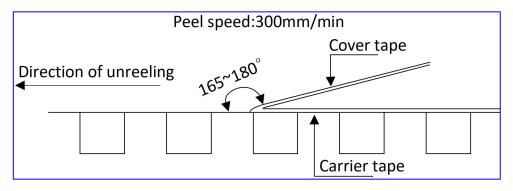
Output: Out

10 Work order number

15.1.5 Sealing Tape Reel Strength

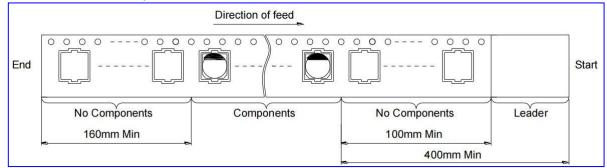
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- 15.1.5.1 Peel angle: 165 to 180°C refered to the surface on which the tape is glued
- 15.1.5.2 Peel speed: 300mm per minutes
- 15.1.5.3 The peel strength must be $0.1 \sim 0.7N$ under these conditions.

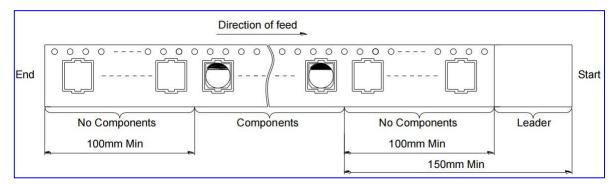


15.1.6 Taping method and polarity

15.1.6.1 5、6、8 phi



15.1.6.2 10 phi





Cautions for Using Aluminum Electrolytic Capacitors

- 1. When reverse voltage is applied on DC aluminum electrolytic capacitor ,the circuit will be short out and the capacitor will be damaged due to abnormal current flows through the capacitor. Please use non- polar types of capacitors when the positive voltage is applied on the cathode terminal.
- 2. When capacitor is used at higher voltage than the rated voltage, leakage current increased, characteristics drastically deteriorated and damaged in a short period may occur as a result. Please take extra caution that the peak voltage should not exceed the rated voltage.
- 3. Sudden charge and discharge

When aluminum electrolytic capacitors for general purpose-use are employed in rapid charge and discharge application, its life expectancy may be shortened resulted from capacitance decrease, heat rise, etc.

4. Storage of the capacitor

 $\textcircled{1}\$ We recommend the following conditions for storage:

Ambient temperature: 5~35°C ,Ambient humidity: <75%RH;

a) Storage life: \leq 12 months;

b) If storage life >12 months, the products need to be charged again before using;

c) If Storage time >three years, the products need to be discarded;

- d) Expiry Date: calculating from the date marked on the sleeve;
- e) Please keep capacitors in the original package;
- f) Avoid storing the capacitors under such circumstances:
- % With water and oil or damp &dewing location.
- ※ With gas and oil.
- % With toxic gases such as hydrogen sulfide, sulfurous acid, nitrous acid, chlorine, bromine and methane.
- % With direct sunlight, Ozone, ultraviolet rays or radiation.

5. If excessive ripple current is applied on the capacitor, excessive heat will be generated inside, the capacitance will be reduced and capacitor's life shall be shortened. Rated voltage has been marked on the capacitor; therefore, the peak value of the ripple voltage should be less than the rated voltage.

6. Ambient temperature

Life of aluminum electrolytic capacitor is affected by the ambient temperature. It is generally known that the life doubles for each 10° C decrease in temperature.

7. Tensile strength of lead wire

When a strong force is applied to the lead wires or terminals, stress is put on the internal connections, which may result in short circuit, open circuit or increased leakage current. So it is not advisable to bend or handle a capacitor after it has been soldered to the PC board.

8. Heat resistance at the soldering process

During soldering process, secondary shrinkage or sleeve crack may occur when soldering temperature is too high or soldering time is too long.

9. Hole pitch and position of PC board

When designing a PC board, its hole pitch should be designed to coincide with the lead pitch (lead spacing) of the capacitor specified in the catalog or specifications. When a capacitor is forcibly inserted into an unmatched hole pitch, a force will put on the leads and which could result in a short circuit or increased leakage current.

10. Cleaning after soldering

Koas

① The aluminum electrolyte capacitors should be fee halogenated solvents during board cleaning after soldering. Use solvent proof capacitors when halogenated solvents are used.

② After cleaned with the solvent which should proof the quality of capacitors, the capacitors should not be kept in solvent environments of non-ventilated places. Let the capacitors after cleaning dry with hot blast fully above 10mins and the temperature of hot blast should not be over than specified upper limit of capacitors.

11. Adhesives, fixative and coating materials(coating agent)

① Do not use halogenated adhesives and coating materials to fix aluminum electrolytic capacitors.

②Do not cover up all the sealing area of capacitors with adhesives 、 fixative or coating materials(coating agent), make coverage only partial

12. Certificates

- ① ISO 9001:2015
- ② ISO 14001:2015
- ③ ISO/IATF 16949:2016
- ④ OHSAS 45001:2016

※ 符合 RoHS2.0 RoHS compliance

Accord with the latest standard of RoHS2.0, if customers have any special requirments, according to the relevant agreements which signed by both parts.